

TRF1115EVM

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1 Introduction

1.1 Overview

This is the user's guide for the TRF1115 evaluation module (EVM). The TRF1115 is a receive LNA and down-converter with integrated amplifiers and AGC for use in a WiMAX system. The TRF1115 operates in the 2.3-GHz to 2.7-GHz band.

1.2 System Block Diagram

The basic radio system block diagram in [Figure 1](#) demonstrates where the TRF1115 fits in the overall transceiver. The dashed lines indicate the TRF1115 device.

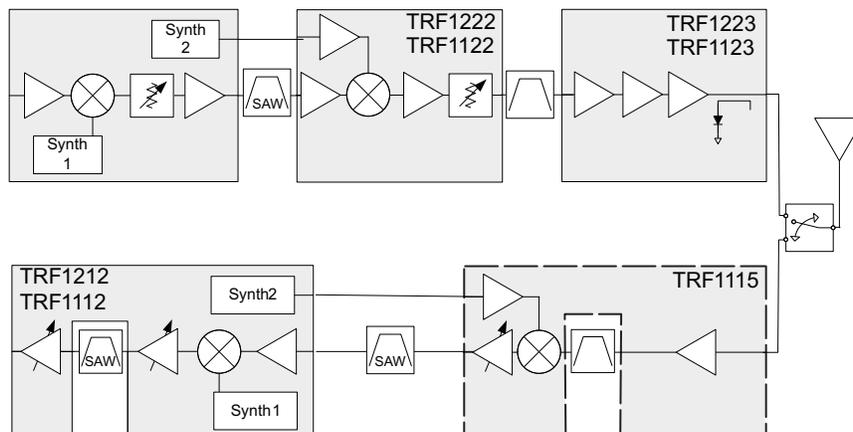


Figure 1. System Block Diagram

2 EVM Test Configuration

2.1 Test Block Diagram

The test setup for general testing of the TRF1115 is shown in [Figure 2](#).

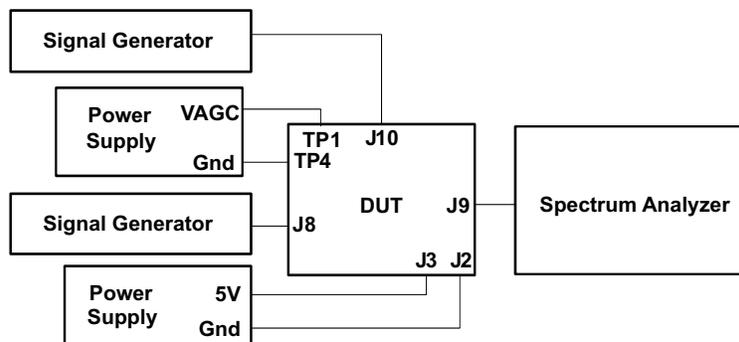


Figure 2. Test Setup Block Diagram

2.2 Test Equipment

The following equipment is required for completing RF testing:

- Power supply with current readout (x2) Agilent E3631 or equivalent
- Signal generator for input signal Agilent E4438C or equivalent
- Signal generator for LO source Agilent E4438C or equivalent
- Spectrum analyzer Agilent E4440A or equivalent

2.3 Calibration

The output RF cable and input LO cable should be good-quality RF cables due to the high-frequency signals.

- Measure the insertion loss of the RF input cable at the frequency of operation. Compensate for the loss of this cable by incrementing the amplitude of the signal generator over the desired value by the amount of insertion loss. For example, if the insertion loss of the cable is 1.5 dB and the desired set point is -45 dBm, the amplitude of the generator should be set to -43.5 dB.
- Measure the insertion loss of the RF cable used to inject the LO signal at the frequency of operation. Compensate for the loss of this cable by incrementing the amplitude of the signal generator over the desired value by the amount of insertion loss. For example, if the insertion loss of the cable is 1.2 dB and the desired set point is 0 dBm, the amplitude of the generator should be set to 1.2 dB.
- Measure the insertion loss of the IF out cable at its frequency of operation. Compensate for the loss of this cable by adjusting the reference level offset in the spectrum analyzer.

3 Basic Test Procedure

This section outlines the basic test procedure for testing the EVM. The last section is not required for basic functionality but is included for reference.

3.1 Initial Inspection

- Verify that the jumper connection at J6 is at the *Ext* location.

3.2 DC Test

- Connect +5 V to J3; connect ground to J2.
- Engage power supplies.
- Verify that current on is 175 ± 25 mA

3.3 Basic RF Test

- Inject 2400-MHz CW signal in at J8 at -45 dBm; ensure that the RF output cable loss is compensated for.
- Connect spectrum analyzer at J9.
- Set spectrum analyzer center frequency to 456 MHz.
- Connect second power supply for AGC control to TP1: *AGCExt* and set to 1.5 V; ground can be connected at J2 or at TP4.
- Connect second signal generator at J10 and set to 0 dBm at frequency: 1944 MHz; ensure that LO cable loss is compensated for.
- Adjust AGC control for minimum gain by adjusting AGC voltage to 1.5 V.
- Measure signal at 456 MHz, and verify signal at -40 dBm ± 3 dB.
- Adjust AGC control for maximum gain by adjusting AGC voltage to 0 V.
- Measure signal at 456 MHz, and verify signal at -30 dBm ± 3 dB.

3.4 Modulated RF Performance

- Inject 3400-MHz modulated signal in at J8 at -45 dBm.
- Set AGC voltage to 0 V for maximum gain.
- Inject CW LO source at J10, and set to 0 dBm at frequency 1944 MHz. Note, this should be a low-phase noise source. Verify LO cable loss is compensated for.
- Connect cable to spectrum analyzer at J9, and initiate WiMAX analysis program.
- Set spectrum analyzer center frequency to 456 MHz.
- Adjust reference level offset to appropriate range for output signal.
- Verify that output signal power is at -28 ± 2 dBm; ensure RF output cable loss is compensated for.

- Verify that EVM performance is less than -40 dB; see [Figure 3](#).

3.5 NF Performance

The noise figure of the evaluation board measured using a noise diode under maximum gain settings over frequency is shown in [Figure 4](#).

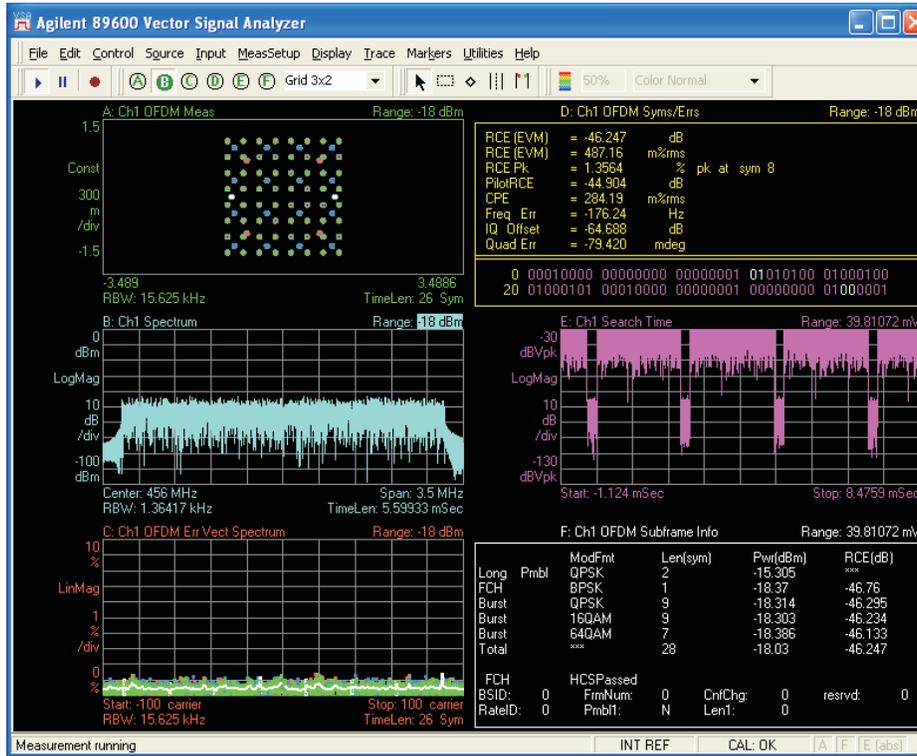


Figure 3. TRF1115EVM Performance

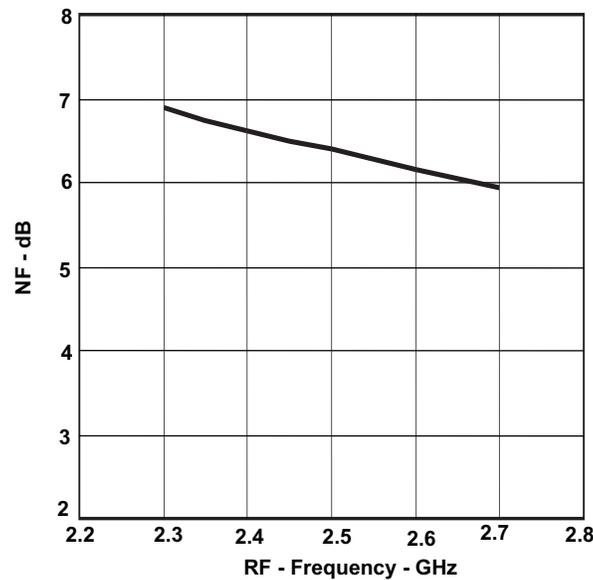


Figure 4. TRF1115 NF Performance

4 Optional Configurations

4.1 External RF Filter

The EVM is configured with the LNA output directly connected to the mixer input. These ports are intended to provide an option for an RF filter at this location. An external filter can be used by installing the jumpers to route the signal to SMA connectors. Note, this option also facilitates monitoring the LNA portion independent of the rest of the chip. To employ this option, the following modifications are required.

- Move R19 to R16 location.
- Move R8 to R18 location.
- Monitor at connectors J4 (LNA output) and J1 (mixer input).

4.2 Differential Inputs

The normal configuration uses transformers and baluns to convert the differential signals to single ended to facilitate laboratory testing. If desired, any of the inputs can be converted to differential operation, which may be desirable when cascading one or more of the chipset's EVMs together.

4.2.1 IF Output

- Remove T1.
- Place R14: 0- Ω resistor (1210).
- Place R10: 0- Ω resistor.
- Differential outputs at J9 and J7.

4.2.2 LO Input

- Remove T2.
- Jumper across pads of T2 (input to output on each side) using a 0- Ω 0201 resistor.
- Place 4.7-pF capacitor at R15.
- Differential inputs at J10 and J11.

4.3 Internal AGC Control

The AGC control can be driven internally by adjusting the resistor potentiometer at R1. To employ this option, move the jumper at J6 to *Int*, and adjust the AGC voltage by tuning the potentiometer at R1 between 0 V and 1.5 V.

5 Physical Description

This section describes the physical characteristics and PCB layout of the EVM and lists the components used on the module.

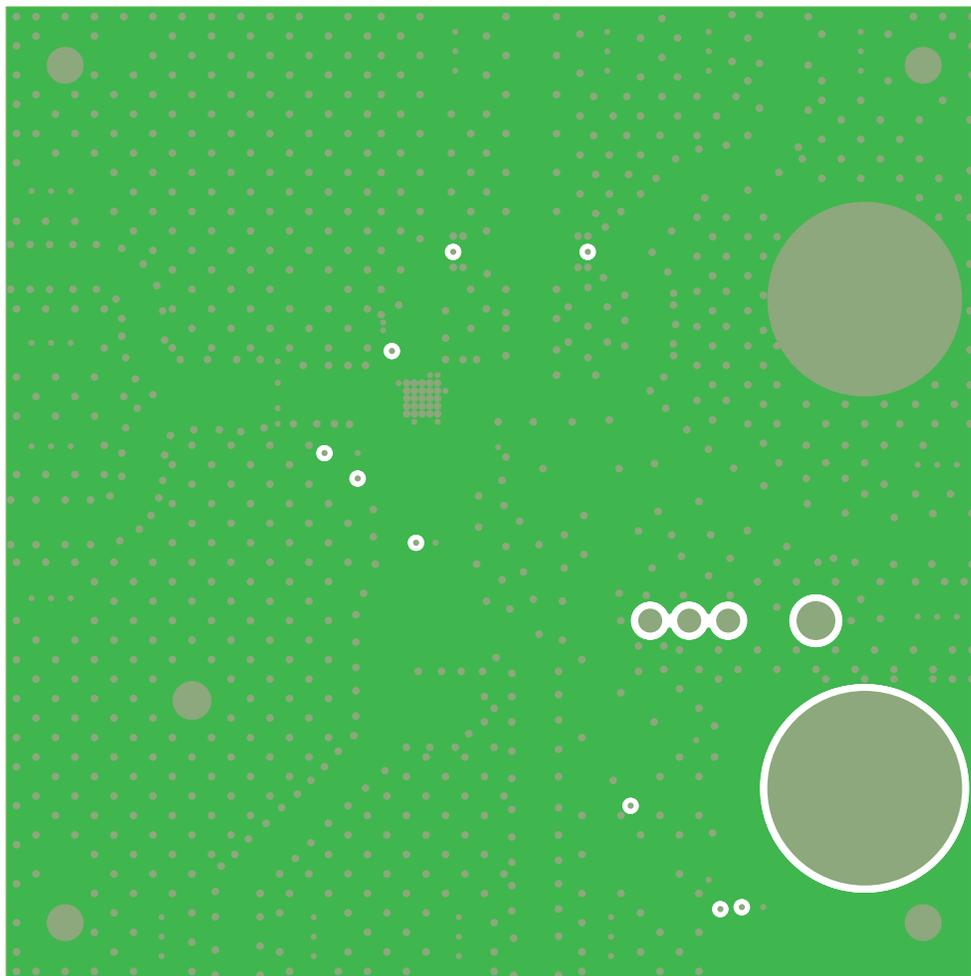


Figure 6. Ground Plane Layer 2

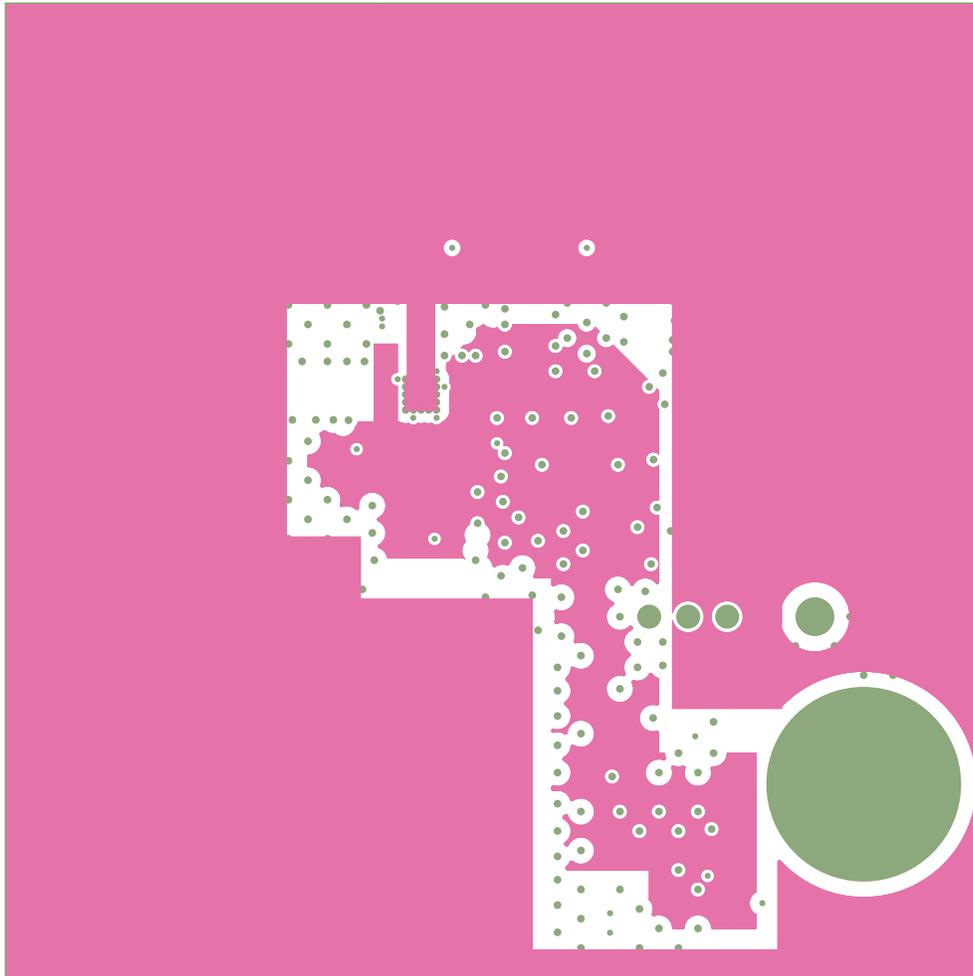


Figure 7. Power Plane Layer 3

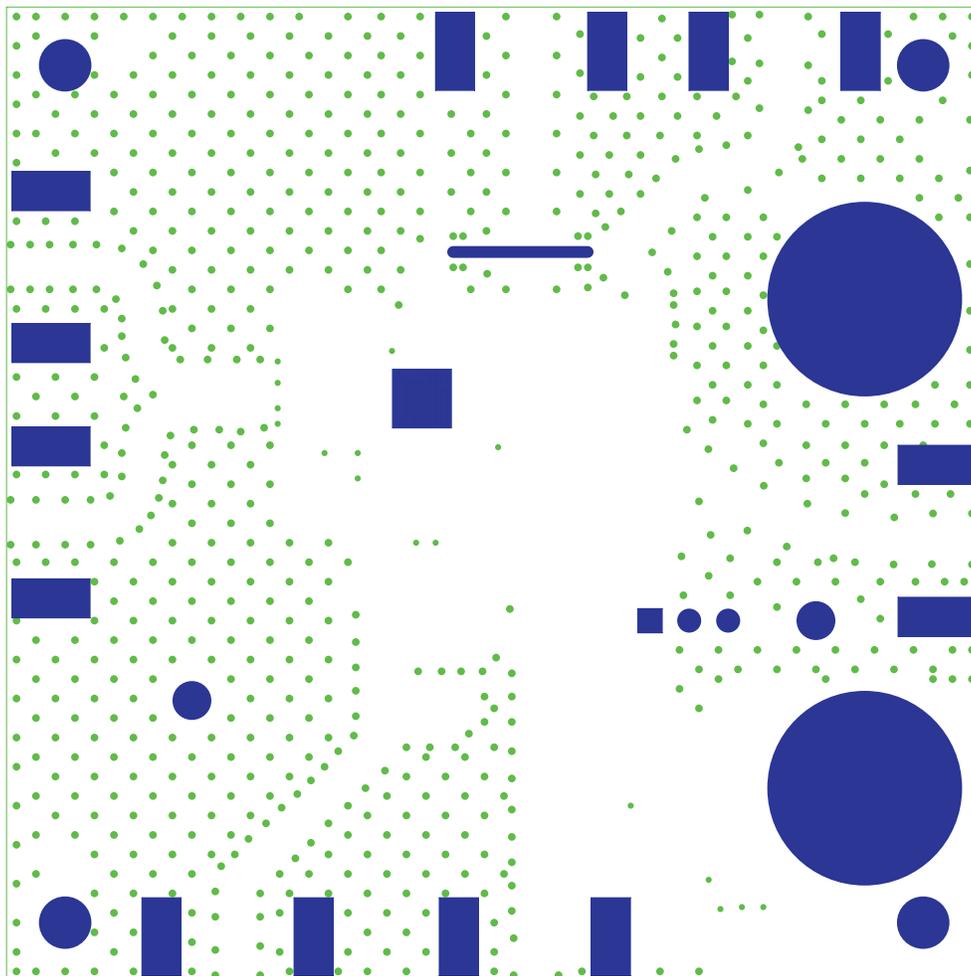


Figure 8. Bottom Layer 4

5.2 Parts List

Table 1 lists the parts used in constructing the EVM.

Table 1. TRF1115EVM Parts List

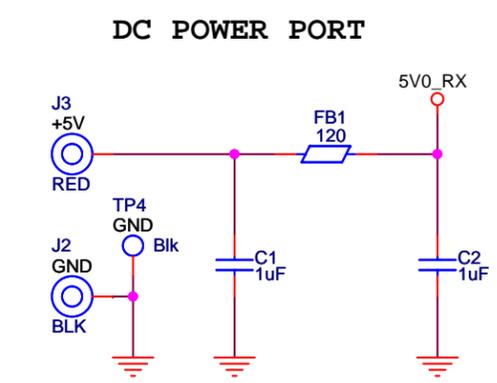
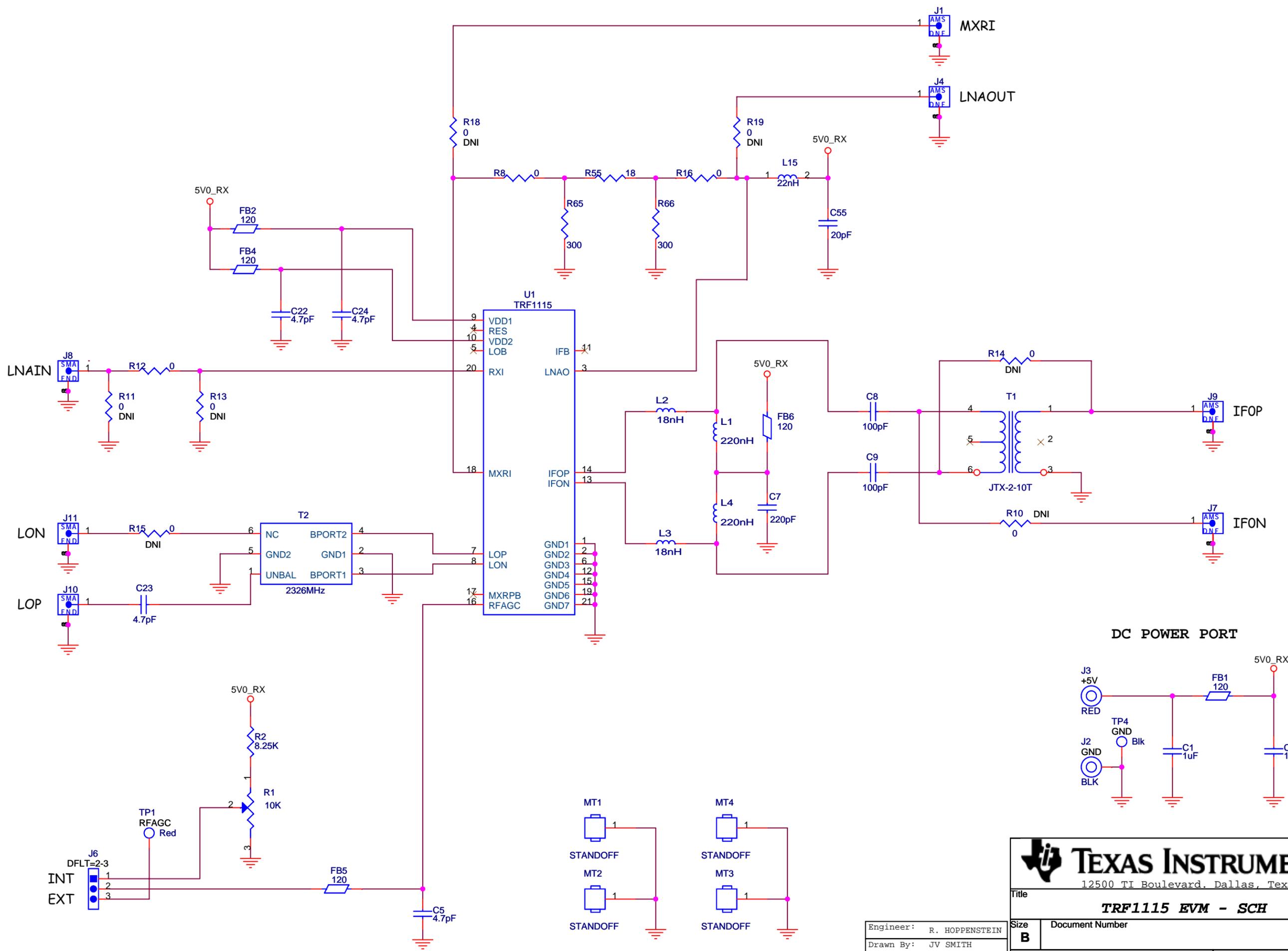
Qty	Reference	Value	Mfr Name	Part Number	Note
2	C1 C2	1 μ F	Panasonic	ECJ-0EB1A105M	
4	C5 C22–C24	4.7pF	Murata	GRM1555C1H4R7CZ01D	
1	C7	220pF	Murata	GRM1555C1H221JA01D	
2	C8 C9	100pF	AVX	0402A101JAT2A	
1	C55	20pF	Murata	GRM1555C1H200JZ01D	
5	FB1 FB2 FB4 FB5 FB6	120	Murata	BLM15AG121SNIB	
7	J1 J4 J7 J8 J9 J10 J11	SMA_END_FLAT	Johnson Components	142-0701-851	
1	J2	BLK	Allied Electronics	ST-351B	
1	J3	RED	Allied Electronics	ST-351A	
1	J6	Header_1x3_100	SAMTEC	TSW-103-07-L-S	
2	L1 L4	220nH	Coilcraft	0603CS-R33XJLU	
2	L2 L3	18nH	Coilcraft	0402CS-18NXKLU	

Table 1. TRF1115EVM Parts List (continued)

Qty	Reference	Value	Mfr Name	Part Number	Note
1	L15	22nH	Coilcraft	0402CS-22NXJL	
4	MT1 MT2 MT3 MT4	STANDOFF	Keystone	3480	STANDOFF
1	R1	10K	Bourns	3214W-1-103E	
1	R2	8.25K	Panasonic	ERJ-2RKF8251X	
3	R8 R12 R16	0	Panasonic	ERJ-2GE0R00X	
0	R10 R11 R13 R15 R18 R19	0	Panasonic	ERJ-2GE0R00X	DNI
0	R14	0	Panasonic	ERJ-8GEY0R00V	DNI
1	R55	18	Panasonic	ERJ-2GEJ180X	
2	R65 R66	300	Panasonic	ERJ-2GEJ301X	
1	T1	JTX-2-10T	Minicircuits	JTX-2-10T	
1	T2	2326MHz	Anaren	BD2326L50100A00	
1	TP1	Red	Keystone	5000	
1	TP4	Blk	Keystone	5001	
1	U1	TRF1115	TI	TRF1115	

5.3 Schematic

The TRF1115EVM schematic appears on the following page.

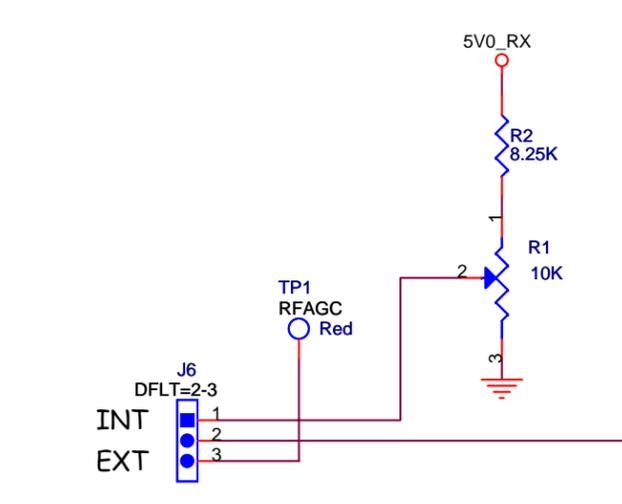
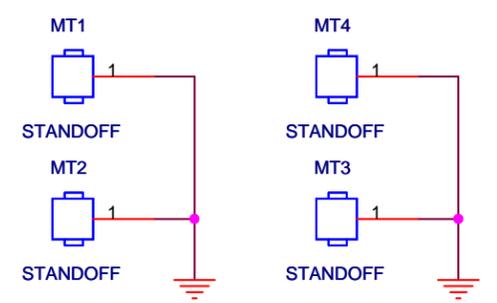


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Title: **TRF1115 EVM - SCH**

Size: B	Document Number	Rev: A
Date: Thursday, August 03, 2006	Sheet 1 of 1	

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EVM WARNINGS AND RESTRICTIONS

It is important to operate this EVM within the input voltage range of 0 V to 5 V and the output voltage range of 0 V to 5 V.

Exceeding the specified input range may cause unexpected operation and/or irreversible damage to the EVM. If there are questions concerning the input range, please contact a TI field representative prior to connecting the input power.

Applying loads outside of the specified output range may result in unintended operation and/or possible permanent damage to the EVM. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative.

During normal operation, some circuit components may have case temperatures greater than 85°C. The EVM is designed to operate properly with certain components above 85°C as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

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